

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	09/705897	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 15:59
L2	0	(mounted adj circuit adj substrate) and (component adj mounting adl pad) and (entire adj surface) and metal and highly and resistanr and erosion and solder and columnar and pattern and thin and film and multilayer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:16
L3	0	(mounted adj circuit adj substrate) and (component adj mounting adl pad) and (entire adj surface) and metal and highly and resistanr and erosion and solder and columnar and pattern	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:16
L4	71	(mounted adj circuit adj substrate) and (component adj mounting adl pad) and (entire adj surface)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:32
L5	2	(mounted adj circuit adj substrate) and (component adj mounting adl pad) and (entire adj surface)and (columnar adj pattern) and multilayer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:33
L6	1	("5284696").PN.	USPAT	OR	OFF	2005/08/03 16:27
L7	0	("8717262").PN.	USPAT	OR	OFF	2005/08/03 16:28
L8	1	("6717262").PN.	USPAT	OR	OFF	2005/08/03 16:32
L9	1	"6452270".PN.	USPAT; USOCR	OR	ON	2005/08/03 16:28
L10	1	"6415974".PN.	USPAT; USOCR	OR	ON	2005/08/03 16:29
L11	1	"6259161".PN.	USPAT; USOCR	OR	ON	2005/08/03 16:30
L12	1	"6030855".PN.	USPAT; USOCR	OR	ON	2005/08/03 16:30
L13	1	"6245594".PN.	USPAT; USOCR	OR	ON	2005/08/03 16:30
L14	1	"5851915".PN.	USPAT; USOCR	OR	ON	2005/08/03 16:31

L15	1	"5445994".PN.	USPAT; USOCR	OR	ON	2005/08/03 16:31
L16	1	"5415920".PN.	USPAT; USOCR	OR	ON	2005/08/03 16:31
L17	1	"5378310".PN.	USPAT; USOCR	OR	ON	2005/08/03 16:31
L18	1	"4949219".PN.	USPAT; USOCR	OR	ON	2005/08/03 16:31
L19	71	(mounted adj circuit adj substrate) and (component adj mounting adl pad) and (entire adj surface)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:32
L20	2	(mounted adj circuit adj substrate) and (component adj mounting adl pad) and (entire adj surface)and (columnar adj pattern) and multilayer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:33
L21	608	438/26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:33
L22	296	438/55	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:33
L23	499	438/64	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:34
L24	3735	438/106	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:34
L25	2188	438/612	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:34

L26	2072	438/613	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:34
L27	1288	438/725	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:34
L28	3983	438/692	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:34
L29	2404	438/689	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/03 16:34